DECLARATION AND POWER OF ATTROENY

As a b low named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

wy residence, post office and chizonship are as stated below flext to my flame,
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter claimed and for which a patent is sought on the invention entitled entitled LOW TEMPERATURE SINTERABLE DIELECTRIC CERAMIC COMPOSITION, MULTILAYER CERAMIC CHIP CAPACITOR AND CERAMIC
ELECTRONIC DEVICE ,
the specification of which [X]is attached hereto
and was amended on (if applicable)
I hereby state that I have reviewed and understand the contents of the above identified specification including the claims as amended by any amendment referred to above.
I acknowl dge the duty to disclose information which is known to me to be material to patentability in accordance with Title 37, Code of Federal Regulations, Section 1. 56.
I h reby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d) or S ction 365(b) of any foreign application(s) for patent or inventor's certificate, or Section 365(a) of any PCT international application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:
Prior Foreign Application(s): Priority Claimed
Number Country Day/Month/Year Filed Yes No
<u></u>
2002-83554 Korea 24/December/2002 XX
I hereby claim the benefit under 35 USC §119(e) of any United States provisional application(s) listed below.
Prior Provisional Application(s) <u>Application Number</u> <u>Filing Date</u>

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s), or Section 365(c) of any PCT international application designating the United States, listed below and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, Unit d Stat s Code, S ction 112, I acknowledge the duty to disclose material information as d fined in Title 37, code of Fed ral R gulations, Section 1.56 which occurred between the filing date of the prior

application and the national or PCT international filing date of this application:

Prior U. S. Application(s)

Serial No.

Filing Date

Status: Patented.Pending. Abandoned

I hereby d clare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may j opardiz the validity of the application or any patent issued thereon.

I her by appoint the following attorney(s) and/or agent(s): Allan M. Lowe, Reg. No. 19.641; B njamin J. Hauptman, Reg. No. 29,310; Israel Gopstein, Reg. No. 27,333; Kenneth M. Berner, Reg. No. 37,093; Michael G. Gilman, Reg. No. 19,114; and Randy Noranbrock, Reg. No. 42, 940, all of

with full power of substitution and revocation, to prosecute this application and to transact all business in

LOWE HAUPTMAN GOPSTEIN GILMAN & BERNER, LLP 1700 Diagonal Road, Suite 310 Alexandria, Virginia 22314

the Pat nt and Traden to them.	nark Office connected therewith, and all future correspondence should be addressed
******	********************************
Full name of sole or fire	st inventor: Dong Hwan Seo
Inventor's signature:	Sea Dong Huan Date: June 11, 2003
Residence:	Suwon, Kyungki-do, Korea
Citizenship:	Republic of Korea
Post Office Address:	2-1011 Samsung Apt., Maetan-dong, Paldal-ku, Suwon, Kyungki-do, Korea
******	***************************************
Full name of second jo	int inventor: Jong Hee Kim
Inventor's signature:	My Jong Hee Date: June 11, 2003
Residence:	Seoul, Korea
Citiz nship:	Republic of Korea
Post Office Address:	215-105 Family Apt., Moonjung-dong, Songpa-ku, Seoul, Korea

Full name of third joint	inv ntor: Sung Hyung Kang
Inventor's signature:	S. H. tang Date: June 11, 2003
Residence:	Suwon, Kyungki-do, Korea
Citizenship:	Republic of Korea
Post Office Address:	173-3 Maetan-dong, Paldal-ku, Suwon, Kyungki-do, Korea
*******	***************************************
Full name of fourth joir	nt inventor: Soon Mok Choi
Inventor's signature:	Somt Moke Cher Date: June 11, 2003
Residence:	Seoul, Korea
Citiz nship:	Republic of Korea
Post Office Address:	102-1204 Geukdong Apt., Sadang 2-dong, Dongjak-ku, Seoul, Korea
******	*********************************
Full name of fifth joint	inventor: Hyuk Joon Youn
Inventor's signature:	
Residence:	Suwon, Kyungki-do, Korea
Citiz nship:	Republic of Korea
Post Office Address:	139-401 Hwanggolmaul Apt., Youngtong-dong, Paldal-ku, Suwon,
	Kyungki-do, Korea

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